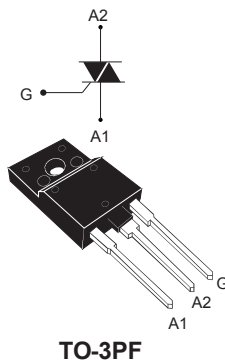


## 40 A Snubberless™ Triac



### Features

- High current Triac
- High surge current = 400 A
- Max. blocking voltage =  $V_{DRM}$ ,  $V_{RRM}$  = 600 V
- Max. surge voltage =  $V_{DSM}$ ,  $V_{RSM}$  = 700 V
- $I_{GT}$  maximum = 50 mA
- High static and dynamic commutation:
  - $(di/dt)_c$  = 25.1 A/ms
  - $dV/dt$  = 1000 V/ $\mu$ s
- UL1557 certified (file ref. 81734) = 2.5 kV
- Snubberless™ device
- ECOPACK®2 compliant (RoHS and HF compliance)

### Applications

- Heater, ventilation and air conditioning (HVAC)
- Solid state relay (SSR)
- Motor soft starter
- SMPS inrush current limiter

### Description

The device is packaged in a through-hole TO-3PF full plastic insulated.

The T4050-6PF is optimized for the ON/OFF function or phase angle control in applications such as static relays, heating regulation, induction motor starting circuits, light dimmers, motor speed controllers and in many other industrial applications where high immunity and high surge current are required.

Product status link	
<a href="#">T4050-6PF</a>	
Product summary	
$I_{T(RMS)}$	40 A
$V_{DRM}$ , $V_{RRM}$	600 V
$V_{DSM}$ , $V_{RSM}$	700 V
$I_{GT}$	50 mA

# 1 Characteristics

**Table 1. Absolute maximum ratings (limiting values)**

Symbol	Parameter	Value	Unit
$I_{T(RMS)}$	RMS on-state current (full sine wave)	$T_c = 76\text{ °C}$	40 A
$I_{TSM}$	Non repetitive surge peak on-state current (full cycle, $T_j$ initial = 25 °C)	$t = 16.7\text{ ms}$	420
		$t = 20\text{ ms}$	400
$I^2t$	$I^2t$ value for fusing	$t_p = 10\text{ ms}$	1000 A <sup>2</sup> s
$di/dt$	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$ , $tr \leq 100\text{ ns}$	$F = 120\text{ Hz}$ , $T_j = 25\text{ °C}$	50 A/ $\mu$ s
$V_{DRM}/V_{RRM}$	Repetitive peak off-state voltage (50-60 Hz)		600 V
$V_{DSM}/V_{RSM}$	Non repetitive peak off-state voltage	$t_p = 10\text{ ms}$ , $T_j = 25\text{ °C}$	700 V
$I_{GM}$	Peak gate current	$t_p = 20\text{ }\mu\text{s}$ , $T_j = 125\text{ °C}$	8 A
$V_{GM}$	Peak gate voltage		8 V
$P_{G(AV)}$	Average gate power dissipation	$T_j = 125\text{ °C}$	1 W
$V_{ins.}$	Insulation RMS voltage, 1 minute (UL1557 file E81734)		2.5 kV
$T_{stg}$	Storage temperature range		-40 to +150 °C
$T_j$	Operating junction temperature range		-40 to +125 °C
$T_L$	Maximum lead temperature for soldering during 10 s		260 °C

**Table 2. Electrical characteristics ( $T_j = 25\text{ °C}$ , unless otherwise specified)**

Symbol	Test conditions	Quadrants; $T_j$	Value	Unit
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$ , $R_L = 33\text{ }\Omega$	I - II - III	Max.	50
$V_{GT}$			Max.	1.3
$V_{GD}$	$V_D = 600\text{ V}$ , $R_L = 3.3\text{ k}\Omega$	I - II - III $T_j = 125\text{ °C}$	Min.	0.2
$I_L$	$I_G = 1.2 \times I_{GT}$	I - III	Max.	70
		II	Max.	160
$I_H^{(2)}$	$I_T = 500\text{ mA}$ , gate open		Max.	85
$dV/dt^{(2)}$	$V_D = 402\text{ V}$ , gate open	$T_j = 125\text{ °C}$	Min.	1000
$(di/dt)_c^{(2)}$	Snubberless™ ( $dV/dt)_c > 20\text{ V}/\mu\text{s}$	$T_j = 125\text{ °C}$	Min.	25.1

1. Minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT\text{ max}}$

2. For both polarities of A2 referenced to A1.

**Table 3. Static electrical characteristics**

Symbol	Test conditions	$T_j$		Value	Unit
$V_{TM}^{(1)}$	$I_{TM} = 60 \text{ A}$ , $t_p = 380 \mu\text{s}$	25 °C	Max.	1.4	V
$V_{TO}^{(1)}$	Threshold voltage	125 °C	Max.	0.85	V
$R_D^{(1)}$	Dynamic resistance	125 °C	Max.	10	mΩ
$I_{DRM}/I_{RRM}$	$V_{DRM} = V_{RRM} = 600 \text{ V}$	25 °C	Max.	5	μA
		125 °C		7.5	mA

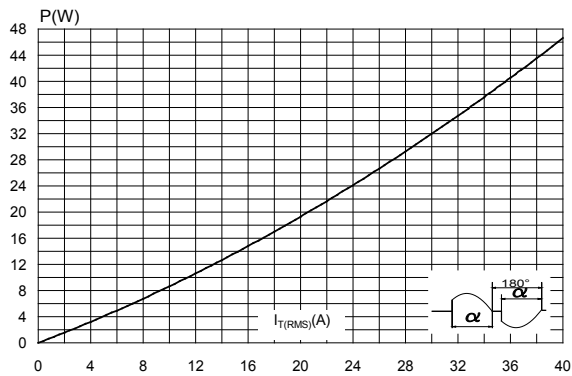
1. For both polarities of A2 referenced to A1.

**Table 4. Thermal resistance**

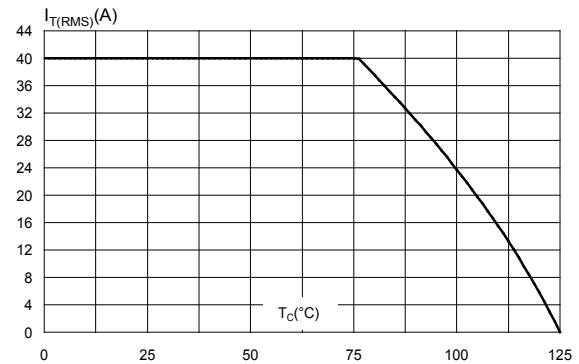
Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	Max.	1.45	°C/W
		Typ.	1.1	
$R_{th(j-a)}$	Junction to ambient	Typ.	50	

## 1.1 Characteristics (curves)

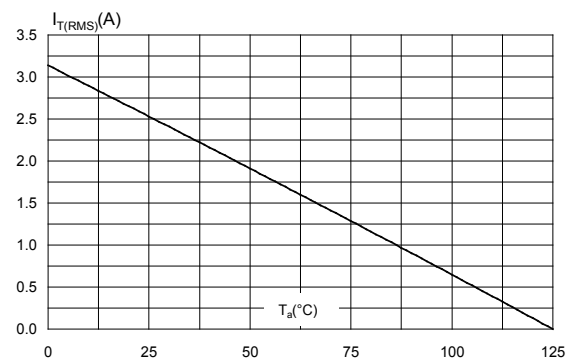
**Figure 1. Maximum power dissipation versus on-state RMS current**



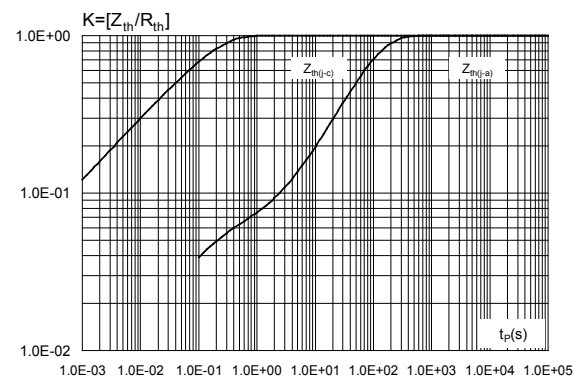
**Figure 2. On-state RMS current versus case temperature**



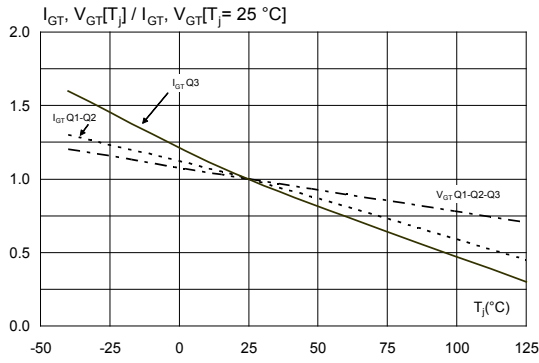
**Figure 3. On-state RMS current versus ambient temperature (free air convection)**



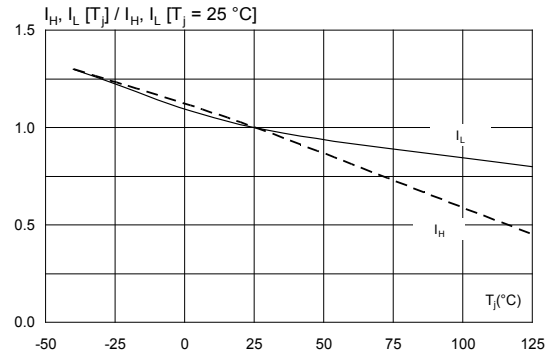
**Figure 4. Relative variation of thermal impedance versus pulse duration**



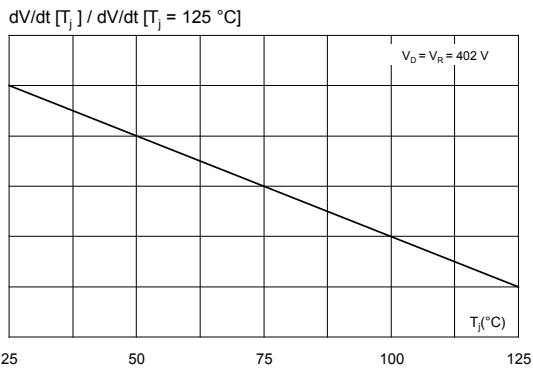
**Figure 5. Relative variation of gate trigger voltage and current versus junction temperature (typical values)**



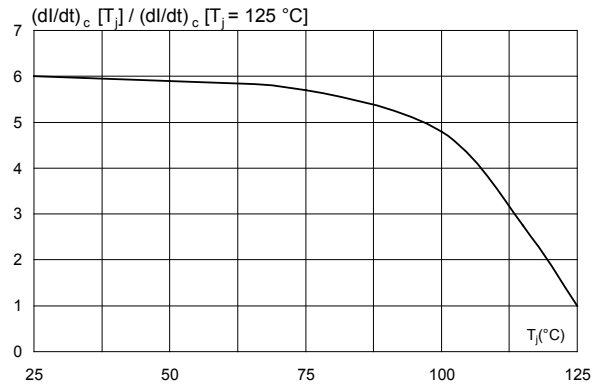
**Figure 6. Relative variation of holding current and latching current versus junction temperature (typical values)**



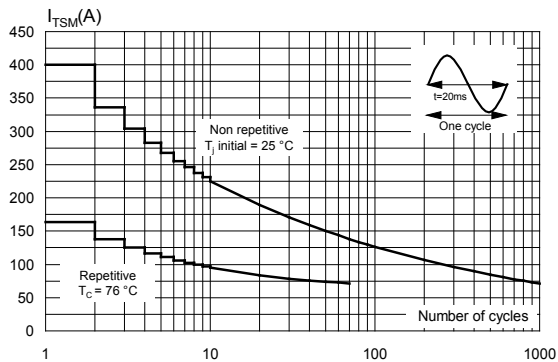
**Figure 7. Relative variation of static dV/dt immunity versus junction temperature**



**Figure 8. Relative variation of critical rate of decrease of main current versus junction temperature**



**Figure 9. Surge peak on-state current versus number of cycles**



**Figure 10. Non repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10$  ms**

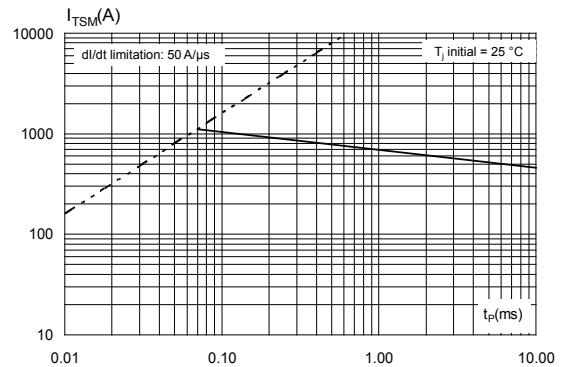


Figure 11. On-state characteristics (maximum values)

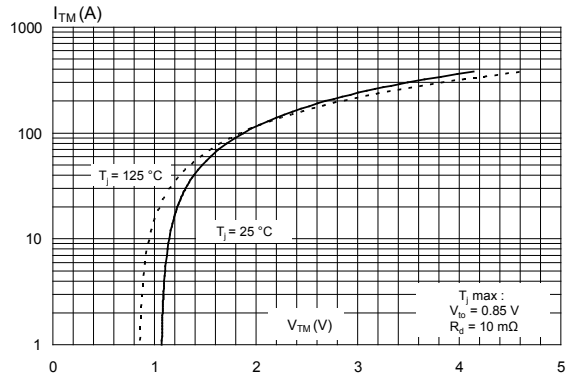
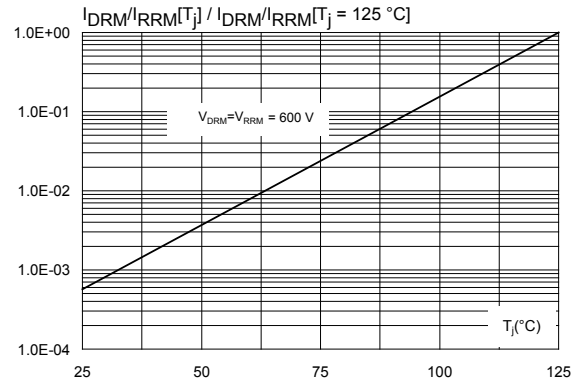


Figure 12. Relative variation of Leakage current versus junction temperature



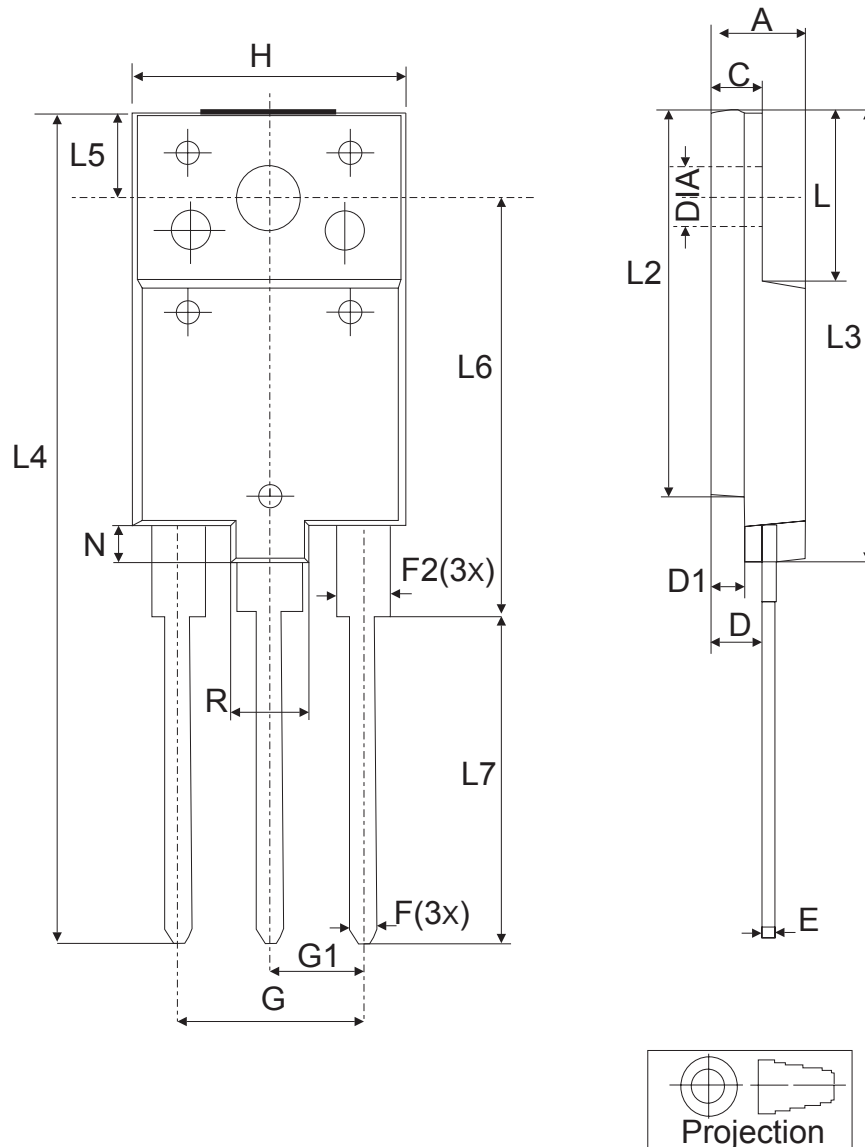
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 2.1 TO-3PF package information

- Epoxy meets UL94, V0
- Lead-free package and HF package
- Recommended torque: 0.8N·m (max. 1.0 N·m)

Figure 13. TO-3PF package outline



**Table 5. TO-3PF mechanical data**

Ref.	Dimensions					
	mm			Inches <sup>(1)</sup>		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	5.30		5.70	0.2087		0.2244
C	2.80		3.20	0.1102		0.1260
D	3.10		3.50	0.1220		0.1378
D1	1.80		2.20	0.0709		0.0866
E	0.80		1.10	0.0315		0.0433
F	0.65		0.95	0.0256		0.0374
F2	1.80		2.20	0.0709		0.0866
G	10.30		11.50	0.4055		0.4528
G1		5.45			0.2146	
H	15.30		15.70	0.6024		0.6181
L	9.80	10.00	10.20	0.3858	0.3937	0.4016
L2	22.80		23.20	0.8976		0.9134
L3	26.30		26.70	1.0354		0.0512
L4	43.20		44.40	1.7008		1.7480
L5	4.30		4.70	0.1693		0.1850
L6	24.30		24.70	0.9567		0.9724
L7	14.60		15.00	0.5748		0.5906
N	1.80		2.20	0.0709		0.0866
R	3.80		4.20	0.1496		0.1654
Dia	3.40		3.80	0.1339		0.1496

1. Inches given for reference only



### 3 Ordering information

Figure 14. Ordering information scheme

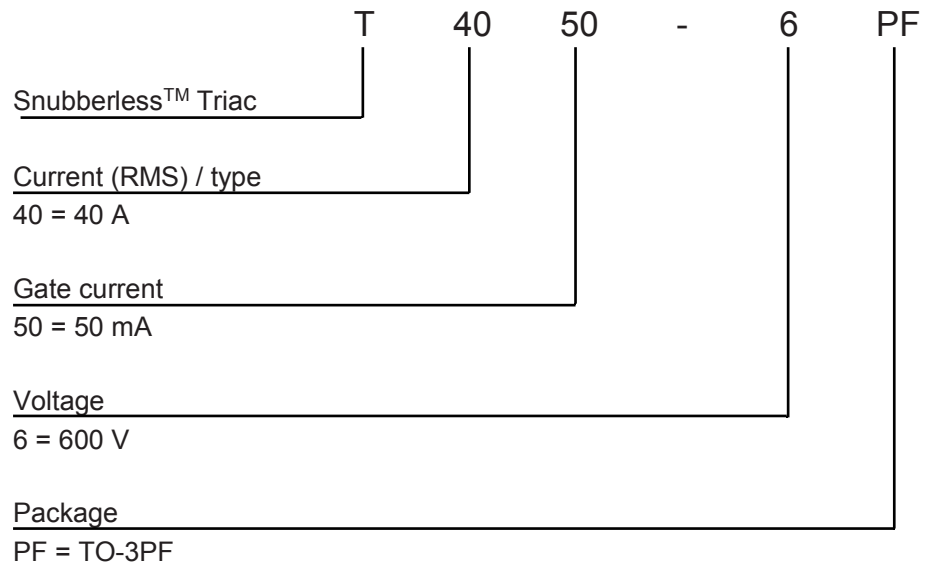


Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T4050-6PF	T4050-6PF	TO-3PF	5.2 g	30	Tube

## Revision history

**Table 7. Document revision history**

Date	Version	Changes
03-Dec-2018	1	Initial release.

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